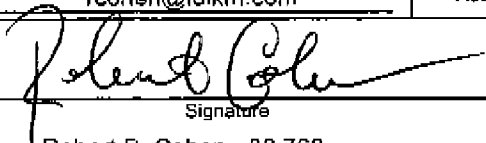


Form PTO-1595 (Rev. 09/04)
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| Execution Date(s): in parentheses after inventor name Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No | | 3. Nature of Conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Government Interest Assignment <input type="checkbox"/> Executive Order 9424, Confirmatory License <input type="checkbox"/> Other _____ | |
| 4. Application or patent number(s): A. Patent Application No.(s) 10/511,634 Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No | | <input type="checkbox"/> This document is being filed together with a new application. B. Patent No.(s) | |
| 5. Name and address to whom correspondence concerning document should be mailed: Name: <u>Robert B. Cohen</u> <u>LERNER, DAVID, LITTENBERG,</u> <u>KRUMHOLZ & MENTLIK, LLP</u> Internal Address: <u>Atty. Dkt.</u> Street Address: <u>600 South Avenue West</u> City: <u>Westfield</u> State: <u>NJ</u> Zip: <u>07090</u> Phone Number: <u>(908) 518-6316</u> Fax Number: <u>(908) 654-7866</u> Email Address: <u>rcohen@ldlkm.com</u> | | 6. Total number of applications and patents involved: <u>1</u> 7. Total fee (37 CFR 1.21(h) & 3.41) \$ <u>40.00</u> <input type="checkbox"/> Authorized to be charged by credit card <input checked="" type="checkbox"/> Authorized to be charged to deposit account <input type="checkbox"/> Enclosed <input type="checkbox"/> None required (government interest not affecting title) | |
| 9. Signature:  _____ Signature Robert B. Cohen - 32,768 Name of Person Signing | | 8. Payment Information a. Credit Card Last 4 Numbers _____ Expiration Date _____ b. Deposit Account Number <u>12-1095</u> Authorized User Name <u>Robert B. Cohen</u> | |
| | | Total number of pages including cover sheet, attachments, and documents: <u>3</u> | |

CH \$40.00 121095 10511634

Docket Number: SONYJP3.3-304
 Sony Reference
 No.: S03P0484US00

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

WIRELESS COMMUNICATION METHOD AND WIRELESS COMMUNICATION APPARATUS

for which an International Application was filed on April 22, 2003, PCT/IP03/05107, designating the United States;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo 141-0001, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: _____, Filing Date: _____.

This assignment executed on the dates indicated below.

Masaki NISHIMURA
 Name of First or Sole Inventor

Execution Date of U.S. Patent Application

Saitama, Japan
 Residence of First or Sole Inventor

Masaki Nishimura
 Signature of First or Sole Inventor

November 12, 2004
 Date of this Assignment

PATENT
REEL: 016215 FRAME: 0834

Docket Number: SONYJP 3.3-304
Sony Reference
No.: S03P0484US00

Shinobu IZUMI

Name of Second Joint Inventor

Execution Date of U.S. Patent Application

Saitama, Japan

Residence of Second Joint Inventor

Shinobu Izumi

November 16, 2004

Signature of Second Joint Inventor

Date of this Assignment

Satoru MAEDA

Name of Third Joint Inventor

Execution Date of U.S. Patent Application

Kanagawa, Japan

Residence of Third Joint Inventor

Signature of Third Joint Inventor

Satoru Maeda

Date of this Assignment

November 16, 2004